



深圳市拓展光电有限公司

TuoZhan Optoelectronics Company Limited

产品规格书

Product Specification

| | | | |
|---|-----------------------|-----------------------|--------------------|
| 产品料号/ Part No. | P2-0402B1TS2-045T-001 | | |
| 产品名称/ Product Name | 0402蓝光 | | |
| 客户名称/ Customer Name | | | |
| 客户料号/ Customer No | | | |
| 生效日期/ Effective Date | | | |
| 制作 Prepared | 审核 Checked | 核准 Approved | 业务 Sales |
| | | | |
| 客户确认（盖章） Customer confirmation（Stamp） | | | |

地址：深圳市宝安区西乡铁岗宝田一路 369 号

TEL:0755-29632541

Address: No.369,Baotian Road,Tiegang,xixiang,Baoan District, Shenzhen

Tel:0755-29632541

注：如中英译文有冲突请以中文为准。

Note: In case of any conflict between Chinese and English translations, the Chinese version shall prevail.



P2-0402B1TS2-045T-001 Datasheet

0402 patch LED has high reliability, high brightness consistency and large luminous angle; The lamp beads have been tested with strict reliability, and the appearance size is small.

0402贴片led可靠性高, 亮度一致性高、发光角度大; 灯珠经过严格的信赖性实验, 外观尺寸小

Blue LED light source with peak wavelength of 457nm. 峰值波长为457nm的蓝色LED光源。



This part has a footprint that is compatible to most of LEDs with similar size.

此器件可与大部份外形尺寸相似的LED兼容使用

FEATURES/特点

- 457nm peak wavelength
457nm峰值波长
- High luminous Intensity and high efficiency
发光强度高, 效率高
- Compatible with reflow soldering process
兼容回流焊工艺
- Low thermal resistance/热阻低
- Long operation life/寿命长
- Wide viewing angle at 120°
120° 发光角度
- Epoxy resin package/环氧树脂封装
- Environmental friendly, RoHS compliance
材质环保, 符合RoHS要求

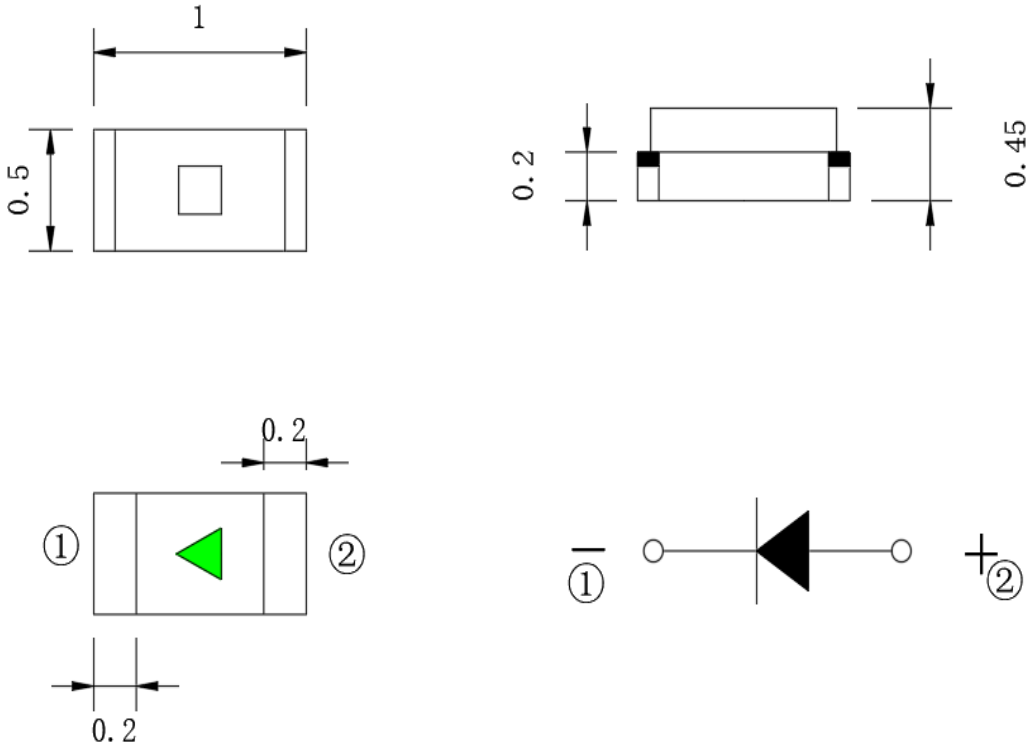
APPLICATIONS/应用

- automotive electronics/汽车电子
- computer/电脑
- cellphone number/手机数码

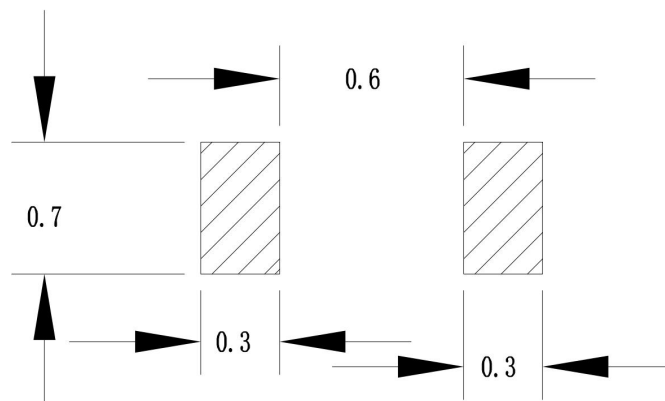
Note: The information in this document is subject to change without notice.



Size of Appearance 外观尺寸



Recommended Solder Pad Design 推荐焊盘设计



Notes/ 注:

1. All dimensions in millimeters.所有尺寸单位为mm
2. Tolerance is ± 0.1 mm unless otherwise noted. 如未特别注明，默认公差为 ± 0.1 mm



ABSOLUTE MAXIMUM RATINGS最大限定参数 (Ta=25°C)

| Parameter 项目名称 | Symbol符号 号 | Value 规格 | Unit 单位 |
|--|-----------------|--|------------|
| 消耗功率 Power Dissipation | Pd | 90 | mW |
| 最大脉冲电流 Max Pulse Current | I _{FP} | 40 | mA |
| 正向直流工作电流 DC Forward Current | I _F | 30 | mA |
| 反向电压 Reverse breakdown Voltage | V _R | 5 | V |
| 抗静电能力 (人体模式) Electrostatic Discharge Threshold (HBM) | ESD | 2500 | V |
| 工作环境温度 Operating Temperature | Topr | -40 to 85°C | °C |
| 储存环境温度 Storage Temperature | Tstg | -40 to 85°C | °C |
| 焊接温度 Soldering Temperature | Tsol | Reflow soldering (回流焊) : 260°C/10S Hands soldering (手工焊) : 320°C/3S | °C |

CHARACTERISTICS 光电参数(Ta=25°C)

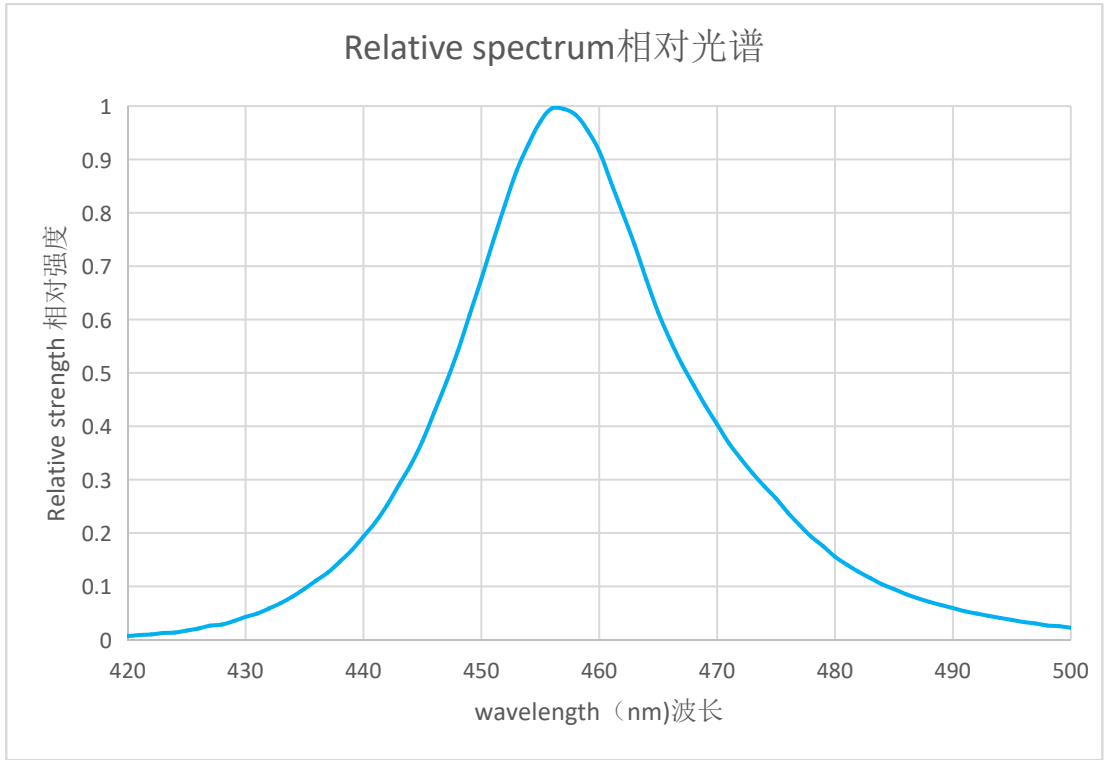
| Parameter 项目名称 | Symbol 单位 | Condition n 条件 | Min 最小值 | Typ 中间值 | Max 最大值 | Unit 单位 |
|----------------------------------|----------------|----------------------|------------|------------|------------|------------|
| 亮度 Luminous Intensity | IV | I _F =5mA | 40 | 50 | 80 | mcd |
| 主波长 Dominant wavelength | λ d | I _F =5mA | 460 | 465 | 475 | nm |
| 正向电压 Forward Voltage | V _F | I _F =5mA | 2.7 | --- | 3.0 | V |
| 峰值波长 Peak Wavelength | λ P | I _F =5mA | --- | 457 | -- | nm |
| 半波宽 Spectrum Radiation Bandwidth | △ λ | I _F =5mA | --- | 18 | --- | nm |
| 反向漏电流 Reverse Current | I _R | V _R =5V | --- | --- | 3 | uA |
| 半功率视角 Half Power View | 2 θ 1/2 | I _F =5mA | --- | 120 | --- | deg |

Notes/注:

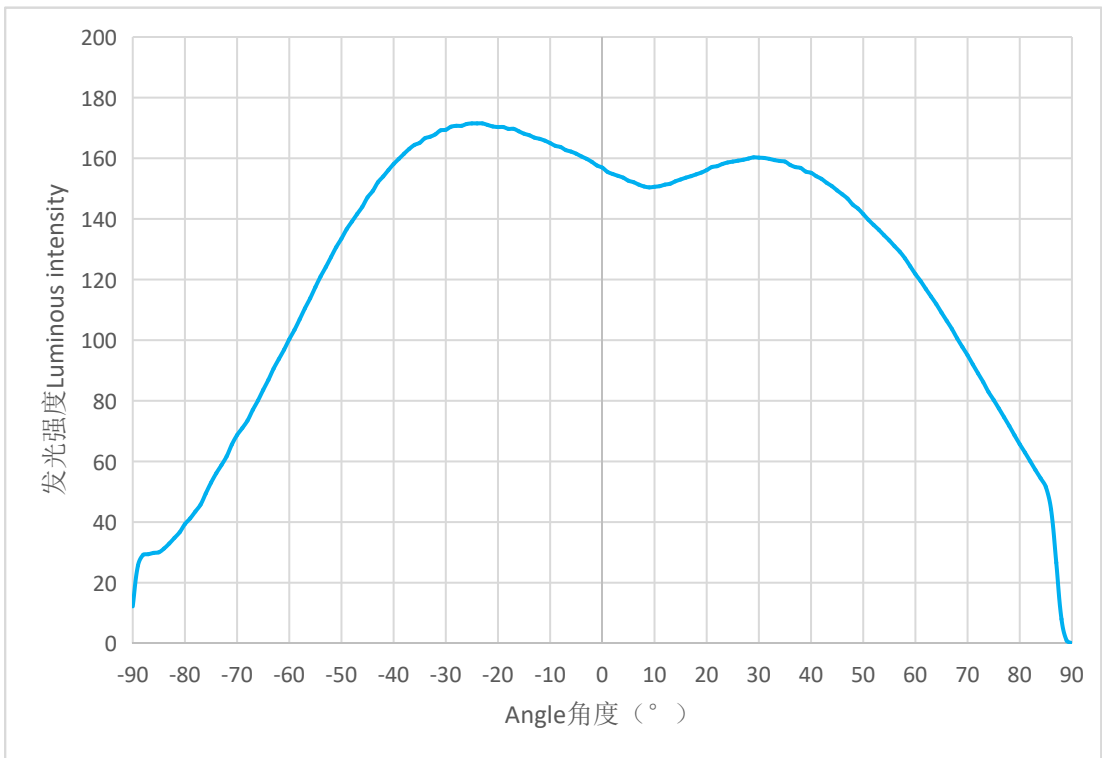
1. peak wavelength is measured with an accuracy of ± 2nm. 峰值波长的测量精度为± 2nm.
2. All measurements were made under the standardized environment of Tuozhan 所有的测量都是在拓展的标准环境下进行的



RELATIVE SPECTRAL POWER DISTRIBUTION 相对光谱功率分布 ($T_j=25^\circ\text{C}$)

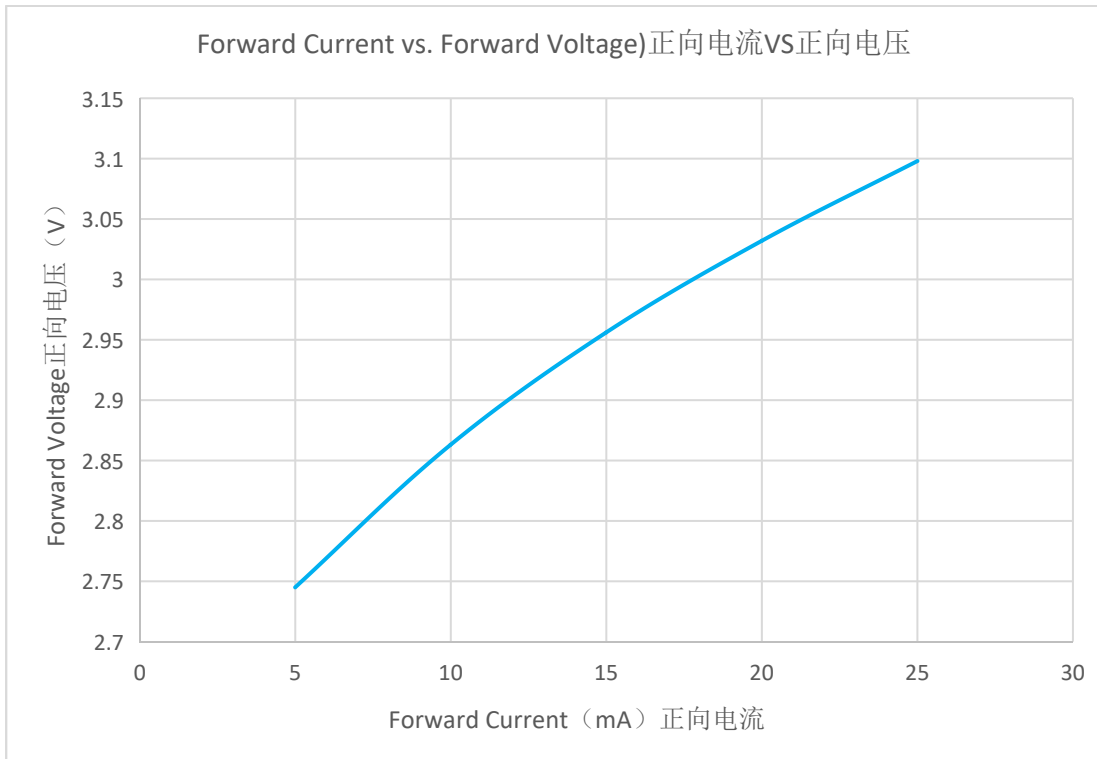


TYPICAL SPATIAL DISTRIBUTION 典型配光分布

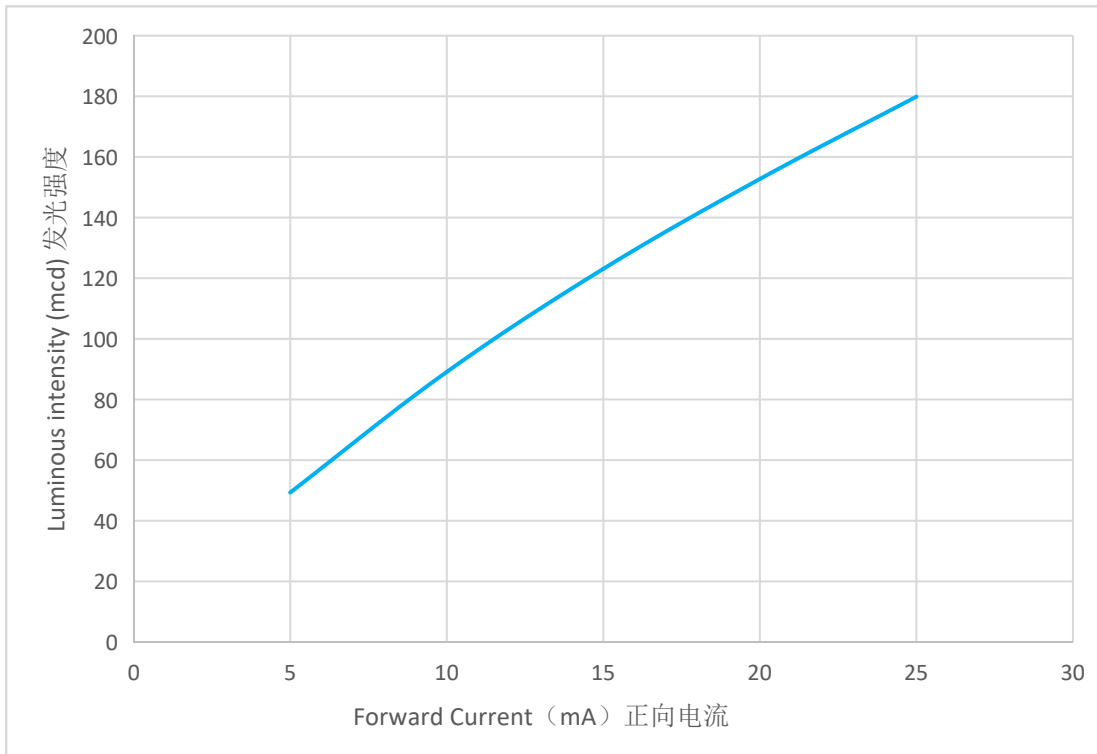




ELECTRICAL CHARACTERISTICS 电特性(Tj=25°C)



CURRENT VS. luminous intensity 电流与发光强度



REFLOW SOLDERING CHARACTERISTICS 回流焊特性

For Reflow Process 回流焊制程:

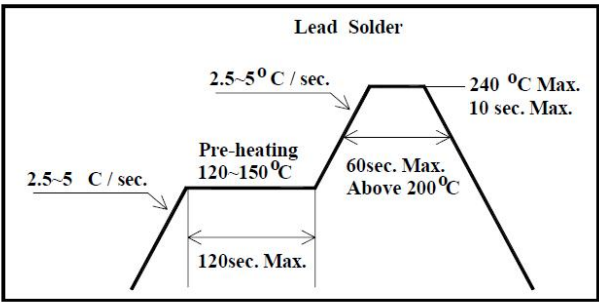
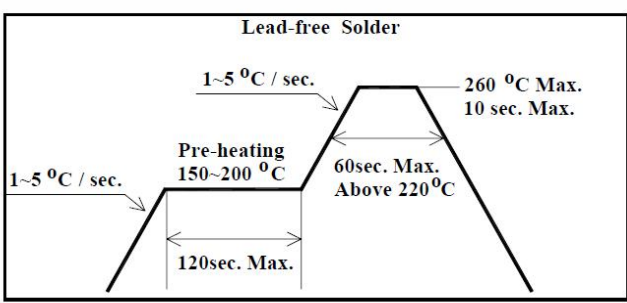
Preheating 预热 : 140°C~160°C±5°C, within 2 minutes. 2分钟

Operation heating 作业加热 : 260°C(Max.) within 10 seconds.(Max)

260°C(最高) within 10 seconds.(最长)

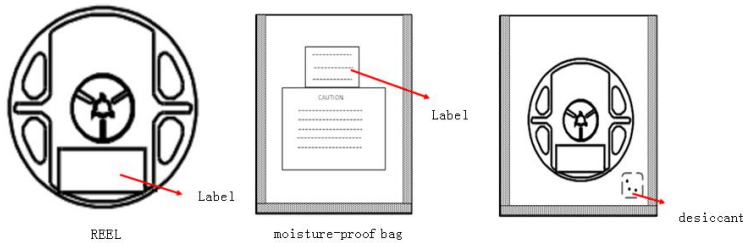
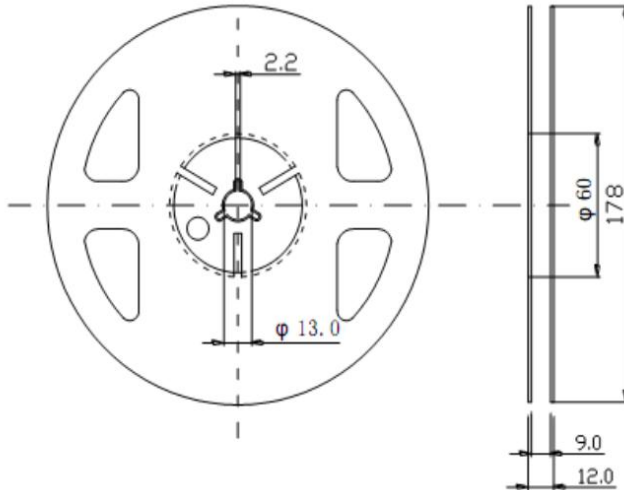
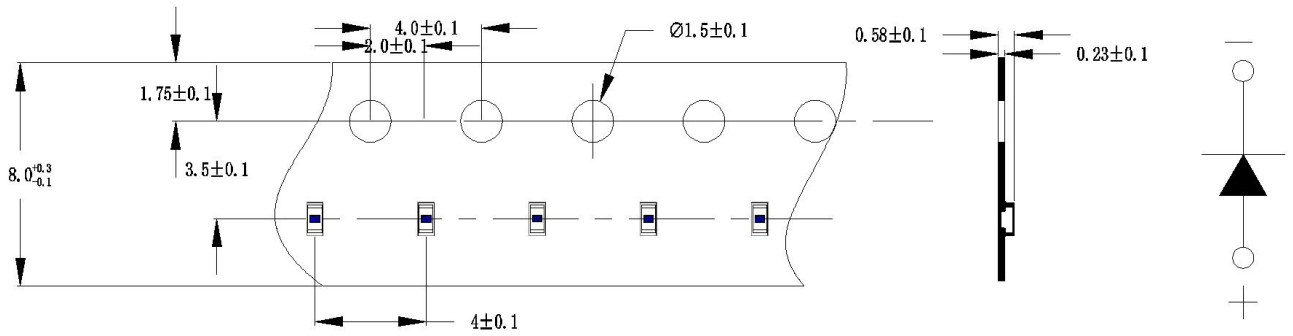
Gradual Cooling (Avoid quenching). 逐渐冷却(避免淬火)

| Lead solder 有铅焊接 | | Lead-free solder 无铅焊接 | |
|--------------------------------|--------------|--------------------------------|--------------|
| Pre-heat 预热 | 120-150°C | Pre-heat 预热 | 150-200°C |
| Pre-heat time 预热时间 | 120 sec.Max. | Pre-heat time 预热时间 | 120 sec.Max. |
| Peak Temperature 峰值温度 | 240°C Max. | Peak Temperature 峰值温度 | 260°C Max. |
| Soldering time condition 回流焊时间 | 10 sec.Max. | Soldering time condition 回流焊时间 | 10 sec.Max. |

| Lead Solder | Lead-free Solder |
|--|---|
|  <p>The diagram shows a reflow profile for Lead Solder. It starts with a heating ramp at 2.5-5 °C/sec. This is followed by a pre-heating plateau at 120-150 °C for a maximum of 120 seconds. The temperature then rises to a peak of 240 °C Max. at a rate of 2.5-5 °C/sec, where it remains for a maximum of 10 seconds. Finally, it cools down at 2.5-5 °C/sec. A note indicates that the pre-heating time above 200 °C is a maximum of 60 seconds.</p> |  <p>The diagram shows a reflow profile for Lead-free Solder. It starts with a heating ramp at 1-5 °C/sec. This is followed by a pre-heating plateau at 150-200 °C for a maximum of 120 seconds. The temperature then rises to a peak of 260 °C Max. at a rate of 1-5 °C/sec, where it remains for a maximum of 10 seconds. Finally, it cools down at 1-5 °C/sec. A note indicates that the pre-heating time above 220 °C is a maximum of 60 seconds.</p> |



TAPE AND REEL 编带



Notes注:

- (1) Quantity : 5,000pcs/Reel
数量: 5000pcs/卷
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2\text{mm}$
累积公差: 累积公差/10间距 ± 0.2 毫米
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 20-40N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
盖带粘附强度: 盖带反向拉, 与载带角度为 10° , 拉力为20-40N
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.
包装: 品名, 生产数据代码和数量须在防潮包装上注明



Reliability Test Items 可靠性测试项目

| Test Items 测试项目 | Test Duration 测试时长 | Number of Damaged 不良数 |
|--|--------------------|-----------------------|
| Steady State Operating Life of High Temperature (HTOL) Ts=85°C, IF=Max 高温点亮稳态老化Ts=85°C, IF=最大值 | 1000hrs | 0/20 |
| Steady State Operating Life of Low Temperature (LTOL) Ta=-40°C, IF=Max 低温点亮稳态老化Ts=-40°C, IF=最大值 | 1000hrs | 0/20 |
| Pulse Wet Operating Life of High Temperature (PWHTOL) 高温高湿通断电老化 60°C/90%RH, IF30mins ON/30min OFF | 500hrs | 0/20 |
| High Temperature Storage (HTS) 高温存储 100°C | 1000hrs | 0/20 |
| Low Temperature Storage (LTS) 低温存储 -40°C | 1000hrs | 0/20 |
| Thermal Shock (TS) -45°C~125°C 30min dwell 20sec transfer 冷热冲击-45°C 30min~125°C 30min, 转换时间20秒 | 300cycles | 0/20 |
| Solder Resistance (SR) 265°C, 3X MSL 阻焊测试 (3遍潮气敏感度试验后) | 5sec | 0/20 |
| Solder Ability (SA) 245°C5sec, 95% coverage 可焊性 95%覆盖 | 5sec | 0/11 |
| Mechanical Shock (MS) 1500G 0.5msec pulse shock 机械冲击(MS) 1500G 0.5毫秒脉冲冲击 | Each6 axis | 0/6 |
| Random Vibration (RV) 随机振动 6G RMS, 10-2000Hz, 10min | Per axis | 0/6 |
| Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over 变频振动(VVF) 10-2000-10Hz, 对数或线性扫频, 20G, 1分钟, 1.5mm, 每轴3遍以上 | 6hrs | 0/6 |
| Salt Spread (SS) 35°C, 30g/m2/day 盐雾试验35°C,30克/平方米/天 | 48hrs | 0/11 |

| Item 项目 | Symbol 符号 | Test Condition 测试条件 | Criteria for Judgment 判定标准 | |
|-------------------------|----------------|-------------------------|----------------------------|------------|
| | | | Min. 最小 | Max. 最大 |
| Forward Voltage 正向电压 | V _f | IF=Typical Current 典型电流 | | U.S.L x1.1 |
| light intensity 光强 | mcd | IF=Typical Current | L.S.L x0.7 | |
| Dominant wavelength 主波长 | nm | IF=Typical Current | | U.S.L x1.1 |

U.S.L: Upper standard level 规格上限 L.S.L: Lower standard level 规格下限

Note: 备注

The technical information shown in the datasheet is limited to the typical characteristics, just for reference. It can't be guarantee of any application condition and method.以上技术数据仅为产品的典型值, 只作为参考, 不 作为任何应用条件及应用方式的保证。



PRECAUTION FOR USE 使用注意事项

(1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.

本器件不得用于水、油、有机溶剂等任何流体中。如需清洁，请使用异丙醇进行清洗。

(2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

当LED发光工作时，应根据环境最高温度来确定工作电流。

(3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from TuoZhan, a sealed container with a nitrogen atmosphere should be used for storage.

LED储存环境须保持清洁。如果LED从拓展发货后需储存3个月或更长时间，则应使用氮气柜进行储存。

(4) The LEDs must be used within seven days after opening the moisture proof packing.

Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.

LED须在打开防潮包装后七天内使用。用防潮包装重新包装未使用的产品，折叠以封住开口，然后存放在干燥的地方。

(5) The appearance and specifications of the product may be modified for improvement without notice.

产品外观及规格如有改进，恕不另行通知。

(6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.

LED对静电和浪涌很敏感。在处理LED时，建议使用防静电腕带或防静电手套。

(7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LEDs get unlighted at low current.

手工焊接时，焊接头必须接地。如果对led施加超过绝对最大额定值的过电压，会对led造成损坏。损坏的led会出现一些不寻常的特性，如漏电流明显增加，接通电压降低，低电流时led不亮。

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Standard LEDs - SMD category](#):

Click to view products by [TUOZHAN manufacturer](#):

Other Similar products are found below :

[LTST-C190KYKT](#) [LTST-C19GD2WT](#) [LTST-N683GBEW](#) [LTW-170ZDC](#) [LTW-M140SZS40](#) [LTW-M140ZVS](#) [598-8110-100F](#) [91-21SUBCS400-A6TR7](#) [AAAF5060QBFSEEZGS](#) [APT1608QGW](#) [99-213/R6C-AR2T1B/2C](#) [SML-LX0606SISUGC/A](#) [SML-LXR851SIUPGUBC](#) [LT1ED53A](#) [AM27ZGC03](#) [APFA3010SURKCGKQBDC](#) [APHK1608VGCA](#) [APT2012QGW](#) [LTST-008BGEW](#) [LTW-010DCG](#) [LTW-020ZDCG](#) [LTW-21TS5](#) [LTW-220DS5](#) [LO T67F-V1AB-24-1](#) [598-8330-117F](#) [CMDA20AYAA7D1S](#) [95-21SURCS530-A3TR10](#) [HSMQ-C177](#) [598-8040-100F](#) [598-8070-100F](#) [598-8140-100F](#) [598-8610-200F](#) [SML-LXL1209SYC/ATR](#) [CMD91-21VRC/TR7](#) [SML-512PWT86A](#) [SMF-2432GYC-TR](#) [EASV3015RGYA0](#) [LTST-C190KFKT-5A](#) [LTST-C194TBKT-5A](#) [CLX6E-FKC-CH1M1D1BB7C3D3](#) [SML-LXL0805USBC-TR](#) [SML-LX2835SYSUGCTR](#) [LTW-M670ZVS-M5](#) [APA2106ZGC/G](#) [CLMXB-FKA-CbcfghjnpACBB79463](#) [VFA1101W-5AY3B2-TR](#) [LCB P473-P2R2-3J7L-1-Z](#) [HSMR-C197](#) [LW A67C-S2U1-FK0KM0](#) [LW A673-P1S1-FK0PM0](#)